

客户图

NOTES:

1. FINISH:

- 1.1 HOUSING: LCP BLACK, UL94V-0.
- 1.2 CONTACT: COPPER ALLOY,
GOLD (SEE P/N) PLATED IN CONTACT AREA,
GOLD FLASH PLATED IN SOLDER AREA,
50u" MIN. NICKEL UNDERPLATED OVERALL.

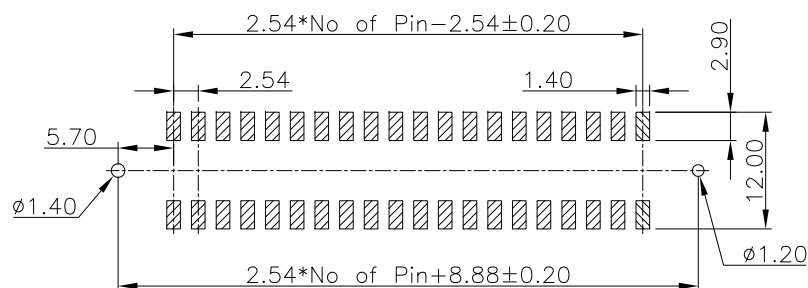
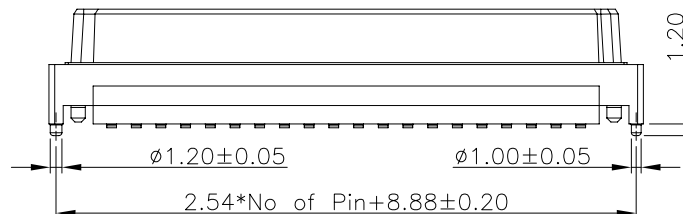
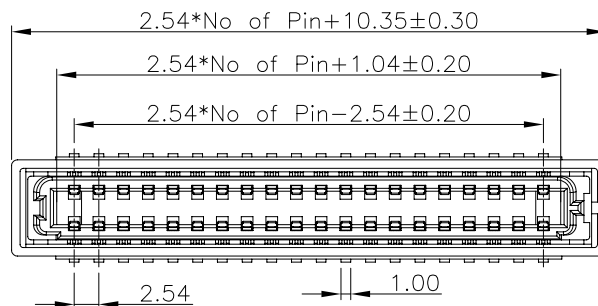
2. ELECTRICAL:

- 2.1 CURRENT RATING: 3A/PIN;
- 2.2 DIELECTRIC WITHSTANDING VOLTAGE: 500V
- 2.3 CONTACT RESISTANCE: 80mΩ MAX.
- 2.4 INSULATION RESISTANCE: 500MΩ MIN.
- 2.5 OPERATION TEMPERATURE: -55°C TO +125°C.

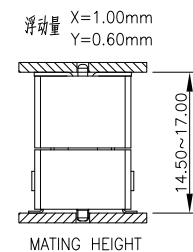
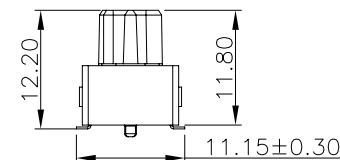
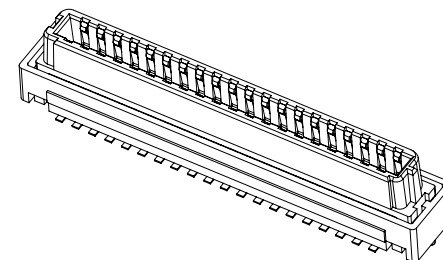
3. ORDER INFORMATION:

66H8-F XXX XX 118 R 01

Pin数码 SEE TABLE 010=2*05PIN ~ 100=2*50PIN (偶数PIN 任意选择)	端子电镀: SN=Gold TIN S1=1u"Gold/Tin S2=3u"Gold/Tin	塑胶高度: 118=11.80mm	包装方式: R=REEL
---	--	----------------------	-----------------



RECOMMENDED PCB LAYOUT(TOP SIDE)
PCB BOARD TOLERANCE±0.05



高度14. 50-40mm
可以按照客户要求定制

					OPERATION		DRAW	WLY	2021.11.18	SOLEPiN 东莞市硕品电子有限公司 Professional connector manufacturer DONGGUAN SOLEPIN ELECTRONICS CO., LTD.			
					X.X	±0.40	DESIGN	Jensen	2021.11.18				
					X.XX	±0.25	CHECK	Jack	2021.11.18				
					X.XXX	±0.15	APPROVE	Andy	2021.11.18				
AO		NEW			Angle	±3°				SHEET	1/1	TITLE:	2.54mm 浮动BTB 母座 SMT
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	DIM.	TOL	UNIT	mm	SCALE	1:1	PROJ.	DRAW NO.	SP-972

客户图

NOTES:

1. FINISH:

- 1.1 HOUSING: LCP BLACK, UL94V-0.
- 1.2 CONTACT: COPPER ALLOY,
GOLD (SEE P/N) PLATED IN CONTACT AREA,
GOLD FLASH PLATED IN SOLDER AREA,
50u" MIN. NICKEL UNDERPLATED OVERALL.

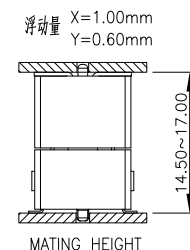
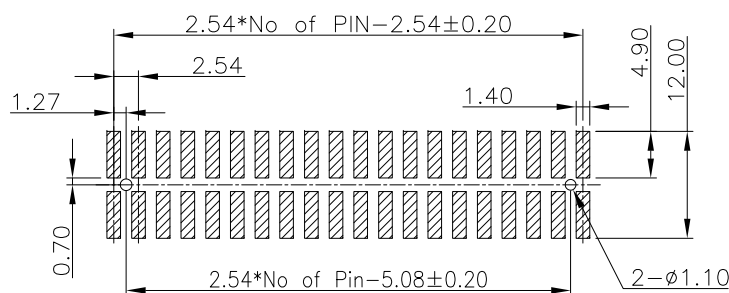
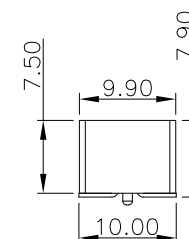
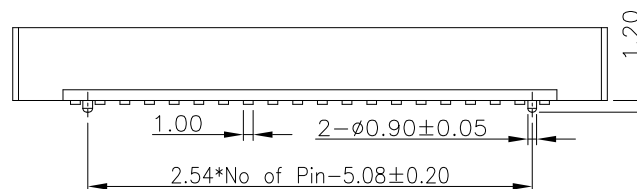
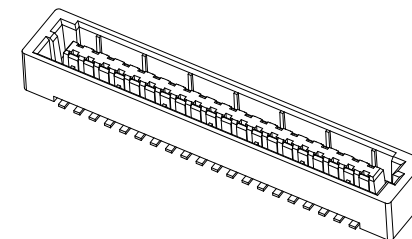
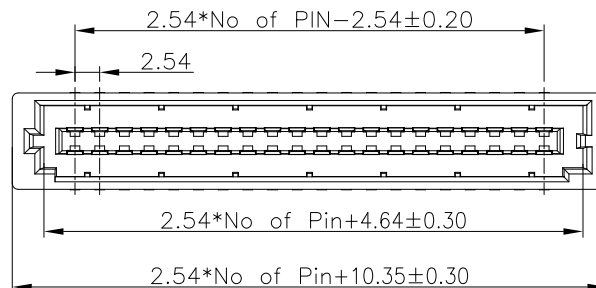
2. ELECTRICAL:

- 2.1 CURRENT RATING: 3A/PIN;
- 2.2 DIELECTRIC WITHSTANDING VOLTAGE: 500V
- 2.3 CONTACT RESISTANCE: 80mΩ MAX.
- 2.4 INSULATION RESISTANCE: 500MΩ MIN.
- 2.5 OPERATION TEMPERATURE: -55°C TO +125°C.

3. ORDER INFORMATION:

66H8-M XXX XX 075 R 01

Pin数码 端子电镀: 塑胶高度: 包装方式:
SEE TABLE SN=Gold TIN 075=7.50mm R=REEL
010=2*05PIN S1=1u"Gold/Tin
~ S2=3u"Gold/Tin
100=2*50PIN
(偶数PIN 任意选择)



高度 14.50~40mm
可以按照客户要求定制

RECOMMENDED PCB LAYOUT(TOP SIDE)
PCB BOARD TOLERANCE±0.05

					OPERATION		DRAW		WLY		2021.11.18		SOLEPiN 东莞市硕品电子有限公司 Professional connector manufacturer DONGGUAN SOLEPIN ELECTRONICS CO., LTD.			
					X.X	±0.40	DESIGN		Jensen		2021.11.18					
					X.XX	±0.25	CHECK		Jack		2021.11.18					
					X.XXX	±0.15	APPROVE		Andy		2021.11.18					
A0		NEW	_____	_____	Angle	±3°					2021.11.18		SHEET	1/1	TITLE:	2.54mm 浮动BTB 公座 SMT
REV	DATE	MODIFICATION DESCRIPTION		CHANGE	APPROVE	DIM.	TOL	UNIT	mm	SCALE	1:1	PROJ.		DRAW NO.	SP-971	